



RoHS Compliant

REV	MODIFICATION	DATE	DRAW
A3	Release To ECN20110508	2011.05.23	Ivy
A4	Release To ECN20110809	2011.09.09	Ivy
A5	Release To ECN20130208	2013.03.07	Seven



Specification

- 1.Current Rating:7A
- 2.Voltage Rating:250V AC/DC
- 3.Contact Resistance:10mΩ Max.
- 4.Insulation Resistance:1000MΩ Min. At DC 500V
- 5.Dielectric Withstanding Voltage:1500 VAC/Minute
- 6.Operating Temperature:-25℃~+85℃

Material:

- 1.Housing:Thermoplastic UL94V-2 Or UL94V-0
- 2.Contact Pin:Copper Alloy SQ Pin=1.14mm

Finish:

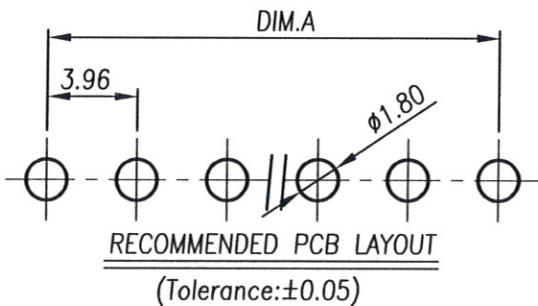
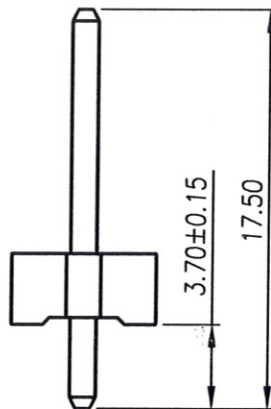
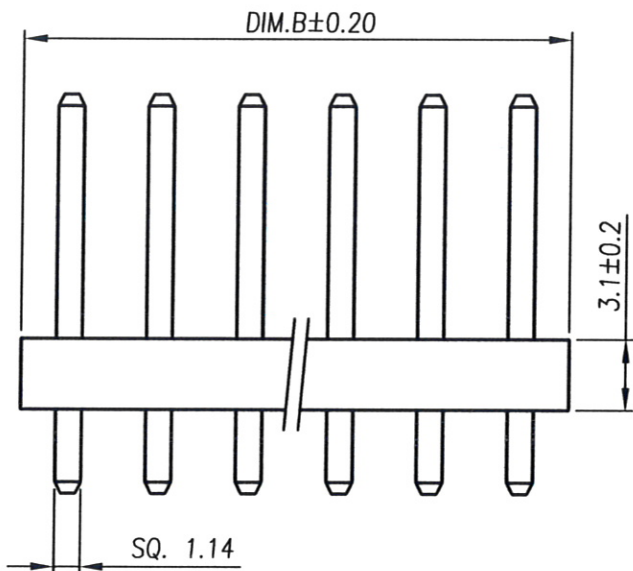
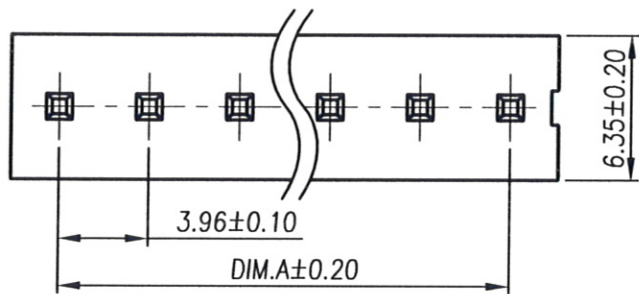
- 1.Housing:Natural
- 2.Contact Pin:See P/N Option...


Part No.: AD02116 XX X X 5 2

Number of Pin Packing
02~16 5:Bag

Housing Material Plating
0:NY66 UL94V-2 Natural 1:Bright Tin Plated Over Ni
1:NY66 UL94V-0 Natural 3:Gold Flash Over Ni


Pin	DIM.A	DIM.B	Pin	DIM.A	DIM.B
02	3.96	8.0	10	35.64	39.9
03	7.92	12.0	11	39.60	43.9
04	11.88	15.9	12	43.56	47.8
05	15.84	20.0	13	47.52	51.8
06	19.80	24.0	14	51.48	55.7
07	23.76	27.9	15	55.44	59.8
08	27.72	31.9	16	59.40	63.8
09	31.68	35.8			





金上達科技股份有限公司

GOLDENSUND TECHNOLOGY CO.,LTD

TOLERANCE UNLESS OTHERWISE SPECIFIED		PROJ. 	TITLE: Wire To Board Wafer 3.96mm 180° DIP		
.x± 0.35	x.'± 2'	APR. Jay 20130307	PART NO. AD02116XXXX52	DWG NO. AD02116XXXX52	
.xx± 0.25	.x'± 1'	CHK. Michelle 20130307	UNITS: mm	CUSTOMER DRAWING	
.xxx± 0.15	.xx'± 0.5'	DRA. Seven 20130307	SIZE: A4	SCALE 3:1	SHEET 1 / 1
			REV A5	V	